

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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LI1806C151R-10

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

A 4.50 [.177] ± 0.25 [.010]

D 0.51 [.020] ± 0.25 [.010]

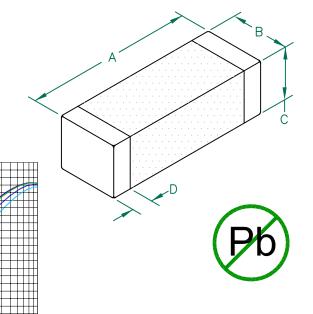
250

200

G 150

IMPEDANCE

Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS

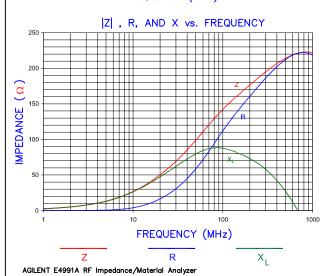


ELECTRICAL CHARACTERISTICS:										
Z @ 100M (<u>Ω</u>)	1Hz	DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current							
Nominal	150									
Minimum	113									
Maximum	188	0.500	300 mA							

NOTES: UNLESS OTHERWISE SPECIFIED

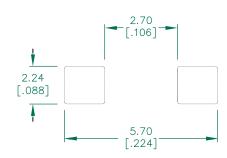
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 2,000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

FREQUENCY (MHz)



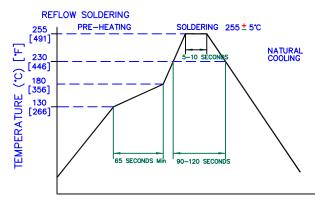
HP 16194A Test Fixture. TEST REF. 3124

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension.)

RECOMMENDED SOLDERING CONDITIONS





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		DIMENSIONS ARE IN mm [INCHE	ES].		This print is the property of Lair	۵						
					Tech, and is loaned in confidence subject to return upon request a							
					with the understanding that no							
	Ш	ADD NOTES 3 AND NOTES 4 UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	copies shall be made without the written consent of Laird Tech. All rights to design or invention are		_	_				
	D	CHANGE REEL QTY FROM 3K TO 2K	11/05/08	JRK	reserved. PROJECT/PART NUMBER:	ᆛ						
	С	UPDATE COMPANY LOGO ADD ROHS SYM	07/22/08	JRK		R	.v F	PART TY		DRAWN BY:		
	В	ADD DC BIAS CURVE CHG REFLOW TEMP.	03/17/03		LI1806C151R-10			CO-	FIRE	JRK		
		CORRECT LANDPATTERN DIMS			PATE: 08/07/02 S	CALE	, N.	TS	SHEET:			
	Α	ORIGINAL DRAFT	08/07/02	JRK	CAD #	00L			_	- 6 0		
	REV	DESCRIPTION	DATE	INT					2 of 2			